



Product Change Notification

Change Notification #: 117336 - 00
Change Title: Intel® Compute Module HNS2600BPBR,
PCN 117336-00, Product Design,
BBIOS/ME/BMC/FRUSDR Firmware Update in
Factory
Date of Publication: December 11, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 26, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on Intel® Compute Module listed in the "Products Affected" table below:

1. Update BIOS revision to R02.01.0009
2. Update Manageability Engine (ME) Firmware revision to 04.01.04.323
3. Update Baseboard Management Controller (BMC) revision to 2.22.59c3b83a
4. Update the FRUSDR revision to 1.41

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
HNS2600BPBR	986116	K36253-002	H87926-562	K36253-003	H87926-563

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 11, 2019	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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